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# 60V N-Channel PowerTrench<sup>o</sup> MOSFET

## **General Description**

These N Channel Logic Level MOSFET have been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

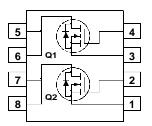
The MOSFET feature faster switching and lower gate charge than other MOSFET with comparable RDS(on) specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

# SO-8

## Features

- 3.5 A, 60 V.  $R_{DS(ON)} = 0.100\Omega$  @ V<sub>GS</sub> = 10 V  $R_{DS(ON)} = 0.200\Omega$  @ V<sub>GS</sub> = 4.5V
- Optimized for use in switching DC/DC converters
  with PWM controllers
- Very fast switching
- Low gate charge.



# Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain-Sourc	Source Voltage		60	V
V <sub>GSS</sub>	Gate-Sourc	e Voltage		±20	V
l <sub>D</sub>	Drain Curre	nt – Continuous	(Note 1a)	3.5	A
		– Pulsed		10	
P₀	Power Dissi	pation for Single Operation	ON (Note 1a)	2	W
			(Note 1b)	1.6	
			(Note 1c)	1.0	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +175	°C
Therma	I Charact	teristics			
$R_{\theta JA}$	Thermal Re	hermal Resistance, Junction-to-Ambient		78 (steady state), 50 (10 sec	) °C/W
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Am	bient (Note 1c)	135	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case		Se (Note 1)	40	°C/W
Packag	e Marking	g and Ordering I	nformation		·
Device Marking		Device	Reel Size	Tape width	Quantity
FDS9945					

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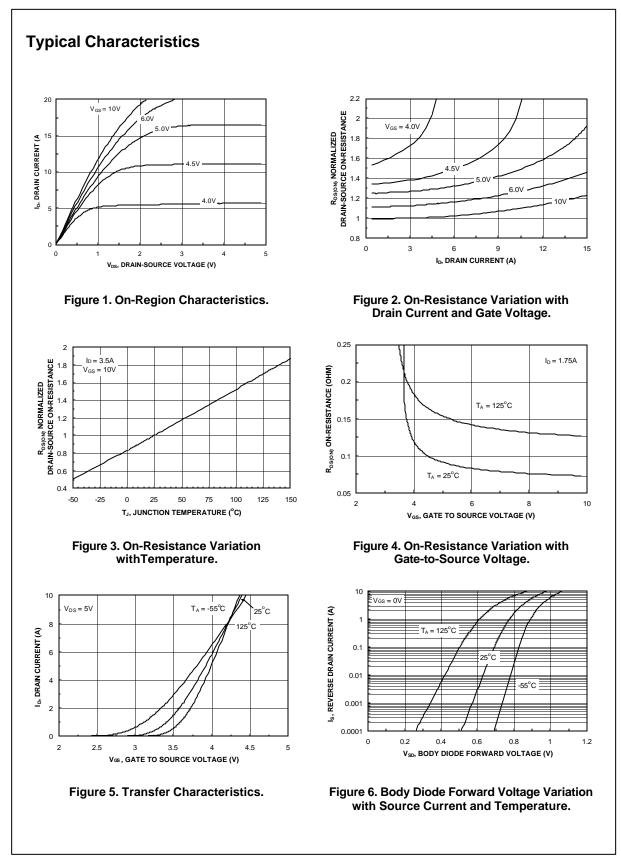
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I				
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		62.5		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2.5	3	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-6		mV/⁰C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			74 103 126	100 200 170	mΩ
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V}, = V_{DS} = 30 \text{ V}$	10			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5V$ , $I_D = 3.5 A$		8.6		S
Dvnamio	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 30 V$ , $V_{GS} = 0 V$ ,		420		pF
Coss	Output Capacitance	f = 1.0 MHz		48		pF
Crss	Reverse Transfer Capacitance	1		20		pF
Switchir	g Characteristics (Note 2)	•	•		•	
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 30 V$ , $I_D = 1 A$ ,		7	14	ns
tr	Turn–On Rise Time	$V_{GS} = 10 V$ , $R_{GEN} = 6 \Omega$		4.3	8.6	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	1		19	34	ns
t <sub>f</sub>	Turn–Off Fall Time	1		3	6	ns
Qg	Total Gate Charge	$V_{DS} = 30 V$ , $I_D = 3.5 A$ ,		8	13	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$		4		nC
∽ys	Gate–Drain Charge	]		2.5		nC
Q <sub>gd</sub>	ource Diode Characteristics	and Maximum Ratings				
Q <sub>gd</sub>	ource Diode Characteristics				2.1	Α

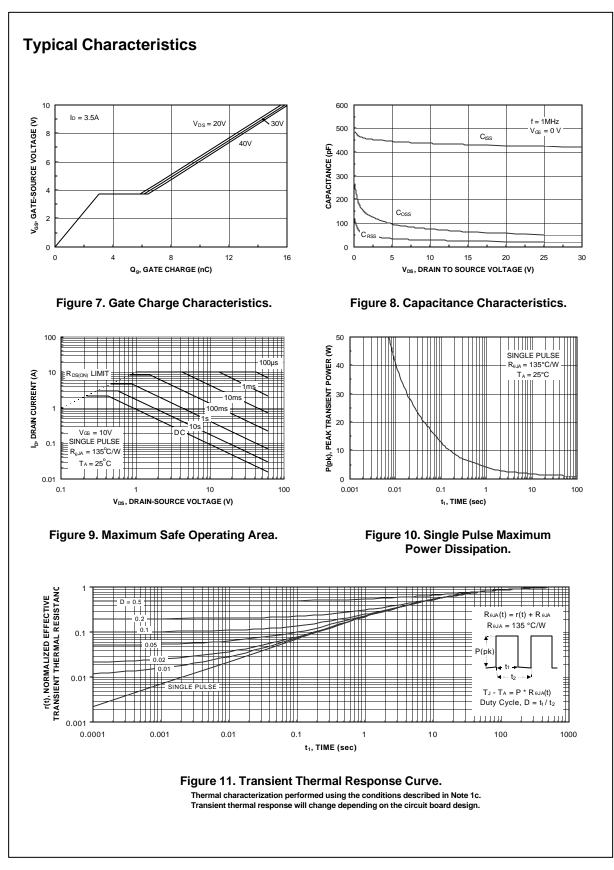
Scale 1 : 1 on letter size paper

6690

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

FDS9945 Rev B(W)





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